

SMD Type

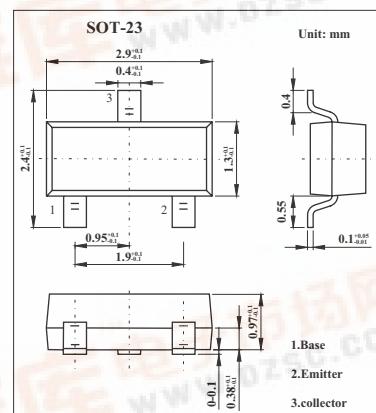
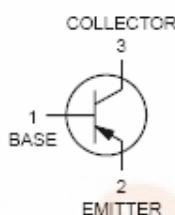
Transistors

Driver Transistors

MMBTA55, MMBTA56

■ Features

- SOT-23 package



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	MMBTA55	MMBTA56	Unit
Collector-emitter voltage	V _{CEO}	-60	-80	V
Collector-base voltage	V _{CBO}	-60	-80	V
Emitter-base voltage	V _{EBO}	-4.0		V
Collector current	I _C	-500		mA
Total Device Dissipation FR-5 Board(* 1)	P _D	225		mW
Derate above 25°C		1.8		mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA}	556		°C/W
Total Device Dissipation Alumina Substrate, (* 2)	P _D	300		mW
Derate above 25°C		2.4		mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA}	417		°C/W
Junction temperature	T _j	150		°C
Storage temperature	T _{stg}	-55 to +150		°C

* 1. FR-5 = 1.0 X 0.75 X 0.062 in.

* 2. Alumina = 0.4 X 0.3 X 0.024 in. 99.5% alumina.

MMBTA55, MMBTA56■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Collector-emitter breakdown voltage* MMBTA55 MMBTA56	$V_{(BR)CEO}$	$I_C = -1.0 \text{ mA}, I_B = 0$	-60			V
			-80			V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E = -100 \mu\text{A}, I_C = 0$	-4.0			V
Base cutoff current	I_{CES}	$V_{CE} = -60 \text{ V}, I_B = 0$			-0.1	μA
Collector cutoff current MMBTA55 MMBTA56	I_{CBO}	$V_{CB} = -60 \text{ V}, I_E = 0$			-0.1	μA
		$V_{CB} = -80 \text{ V}, I_E = 0$			-0.1	μA
DC current gain	H_{FE}	$I_C = -10 \text{ mA}, V_{CE} = -1.0 \text{ V}$	100			
		$I_C = -100 \text{ mA}, V_{CE} = -1.0 \text{ V}$	100			
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = -100 \text{ mA}, I_B = -10 \text{ mA}$			-0.25	V
Base-emitter saturation voltage	$V_{BE(on)}$	$I_C = -100 \text{ mA}, V_{CE} = -1.0 \text{ V}$			-1.2	V
Current-gain-bandwidth product	f_T	$I_C = -100 \text{ mA}, V_{CE} = -1.0 \text{ V}, f = 100 \text{ MHz}$	50			MHz

* Pulse test: pulse width $\leqslant 300 \mu\text{s}$, duty cycle $\leqslant 2.0\%$.

■ hFE Classification

TYPE	MMBTA55	MMBTA56
Marking	2H	2G